

Father D.O.B : - Pardeep Kumar
15/11/1981
Mother D.O.B : - Pinki Devi
1/11/1981

Tamanna mam

Details Required for DS-160 Form

1. Name Himanshu

2. D.O.B 20-5-2003

3. Father Name Pardeep Kumar

4. Mother Name Pinki Devi

5. Aadhar Card Number 939143083454

6. Interview Date

7. Interview Location

8. Mobile Number 9812182117

9. Alternate Mobile Number

10. Parent Mobile Number 9416782117

11. Two Reference Details (Friend/Relatives/Office Colleagues)

A. Name Abhishek

vill. Pasiala Distt. ambala Pincode, 133102

Contact Number 82210 43516

Mail ID abhisaini430@gmail.com

B. Name Pankaj Kumar

vill. Raision, Distt. Karnal, 132157

Contact Number 9571756662

Mail ID b29571756@gmail.com

12. Travel Details of last 5 years

No

13. Have you ever applied for USA before
(if yes)

No

1. When
2. Email Id used
3. Old Ds Number

14. Type of Funding

- A. Private Funding B. Self Funding (Family/Relatives)
- ESM

15. University and Intake Selected for Interview

Murray State University. Aug 2023

16. Have you ever lost your passport?

- a. Yes No

17. Has anyone filed a petition on your behalf?

Ans. No

18. Any Health Disorder?

Ans. No

19. Marital Status?

Ans. Single

20. Are you applying with Spouse/Kids? (If yes mention details)

Ans. No

21. Do you have a social media presence? (If yes mention details)

Ans. Facebook Himanshu Tanwar

22. Have you ever been employed? (If yes mention details)

Ans. No

23. Do you have any relatives in the USA?

Ans. No

Verification- I Himanshu S/O Pardeep Kumar R/O village Kathwah Distt. Kurukshetra, 136135 Haryana

Solemnly declare that I have read the above document carefully and filled all the details willingly and assure no misinterpretation of any details provided above. All the details provided above in the document are true and correct to the best of my knowledge

I authorize my agent to fill these given details in the DS-160 form of my visa application on my behalf and therefore ESM will not be held responsible in case any false information provided in the DS-160.

Himanshu

Signature of the applicant.